

IN THE ABSTRACT:

Please delete the present Abstract of the Disclosure and replace it with the following new Abstract of the Disclosure.

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A method of obtaining a module including at least one inductive winding made up of one or more conductive tracks on a printed circuit film support on which the tracks form turns which are combined to form a winding or a plurality of parallel and/or coaxial windings. The method includes the steps of: stacking a plurality of aligned modular printed circuit film elements carrying a set of turns which are intended to form part of a winding or of a plurality of parallel and/or coaxial windings and whose tracks terminate at or near the edge or one edge of the element that includes them, molding an insulative material over the stacked assembly of modular elements to constitute a rigid block, cutting the molded block laterally along the stack to expose the conductive tracks at a common alignment level and so that they are flush with the surface of one face of the block, which cutting step is performed at least once, and creating connections on the face or faces of the block with which the modular conductive track elements are flush to interconnect them selectively and to connect them to connection means external to the module.